SCOPE:

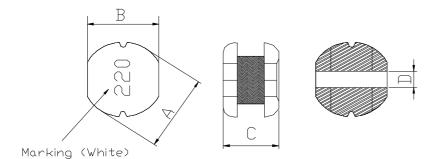
This specification applies to the Pb Free high current type SMD inductors for MSCD-75-SERIES

PRODUCT INDENTIFICATION

MSCD- 75 - 100 K

- 1 2 3 4
- ① Product Code
- **② Dimensions Code**
- **3 Inductance Code**
- **4** Tolerance Code

(1) SHAPES AND DIMENSIONS



A: 7.8 ± 0.3 mm

B: 7.0 ± 0.3 mm

C: 5.0 ± 0.5 mm

D: 2.6 Typ. mm

(2) ELECTRICAL SPECIFICATIONS SEE TABLE 1

TEST INSTRUMENTS

L : HP 4284A PRECISION LCR METER (or equivalent)

RDC: CHROMA MODEL 16502 MILLIOHMMETER (or equivalent)

(3) CHARACTERISTICS

(3)-1 Ambient temperature +60°C Max.

(3)-2 Operate temperature range -40° C $\sim +125^{\circ}$ C (Including self temp. rise)

(3)-3 Storage temperature range -40° C $\sim +125^{\circ}$ C



TABLE 1

MAGLAYERS	Inductance	Percent	Test	Resistance	Rated DC Current		
PT/NO.	L(µH)	Tolerance		RDC(Ω)Max.	IDC(A)	Marking	
			Frequency	` ,	6.30	400	
MSCD-75-1R0□	1.0	M	100kHz/0.25V	20m		1R0	
MSCD-75-1R5	1.5	M	100kHz/0.25V	20m	6.00	1R5	
MSCD-75-2R2	2.2	M	100kHz/0.25V	22m	5.50	2R2	
MSCD-75-3R3□	3.3	M	100kHz/0.25V	24m	3.69	3R3	
MSCD-75-4R7□	4.7	M	100kHz/0.25V	30m	3.00	4R7	
MSCD-75-5R6□	5.6	М	100kHz/0.25V	35m	2.50	5R6	
MSCD-75-6R8□	6.8	M	100kHz/0.25V	40m	2.45	6R8	
MSCD-75-8R2□	8.2	M	100kHz/0.25V	45m	2.40	8R2	
MSCD-75-100□	10	K,M	100kHz/0.25V	70m	2.30	100	
MSCD-75-120□	12	K,M	100kHz/0.25V	80m	2.00	120	
MSCD-75-150□	15	K,M	100kHz/0.25V	90m	1.80	150	
MSCD-75-180□	18	K,M	100kHz/0.25V	0.10	1.60	180	
MSCD-75-220□	22	K,M	100kHz/0.25V	0.11	1.50	220	
MSCD-75-270□	27	K,M	100kHz/0.25V	0.12	1.30	270	
MSCD-75-330□	33	K,M	100kHz/0.25V	0.13	1.20	330	
MSCD-75-390□	39	K,M	100kHz/0.25V	0.16	1.10	390	
MSCD-75-470□	47	K,M	100kHz/0.25V	0.18	1.10	470	
MSCD-75-560□	56	K,M	100kHz/0.25V	0.24	0.94	560	
MSCD-75-680□	68	K,M	100kHz/0.25V	0.28	0.85	680	
MSCD-75-820□	82	K,M	100kHz/0.25V	0.37	0.78	820	
MSCD-75-101□	100	J,K,M	100kHz/0.25V	0.43	0.72	101	
MSCD-75-121□	120	K,M	100kHz/0.25V	0.47	0.66	121	
MSCD-75-151□	150	K,M	100kHz/0.25V	0.64	0.58	151	
MSCD-75-181□	180	K,M	100kHz/0.25V	0.71	0.51	181	
MSCD-75-221□	220	K,M	100kHz/0.25V	0.96	0.49	221	
MSCD-75-271□	270	K,M	100kHz/0.25V	1.11	0.42	271	
MSCD-75-331□	330	K,M	100kHz/0.25V	1.26	0.40	331	
MSCD-75-391□	390	K,M	100kHz/0.25V	1.77	0.36	391	
MSCD-75-471□	470	K,M	100kHz/0.25V	1.96	0.34	471	

[※] ☐ specify the inductance tolerance,J(±5%),K(±10%),M(±20%)

IDC : Based on inductance change (\triangle L/Lo : drop 10% Max.) @ambient temperature 25°C and Based on temperature rise (\triangle T : 40°C TYP.)



(4) RELIABILITY TEST METHOD MECHANICAL

TEST ITEM	SPECIFICATION	TEST DETAILS			
Substrate bending	∆L/Lo≦±5%	The sample shall be soldered onto the printed circuit board			
		in figure 1 and a load applied unitil the figure in the arrow			
	There shall be	direction is made approximately 3mm.(keep time 30 seconds)			
	no mechanical	PCB dimension shall the page 7/9			
	damage or elec-	F(Pressurization)			
	trical damege.	П			
		R5 45±2 45±2 10 20 R340			
		PRESSURE ROD figure-1			
Vibration	∆L/Lo≦±5%	The sample shall be soldered onto the printed circuit board			
		and when a vibration having an amplitude of 1.52mm			
	There shall be	and a frequency of from 10 to 55Hz/1 minute repeated should			
	no mechanical	be applied to the 3 directions (X,Y,Z) for 2 hours each.			
	damage.	(A total of 6 hours)			
Solderability	New solder	Flux (rosin, isopropyl alcohol{JIS-K-1522}) shall be coated			
	More than 90%	over the whole of the sample before hard, the sample shall			
		then be preheated for about 2 minutes in a temperature of			
		130∼150℃ and after it has been immersed to a depth 0.5mm			
		below for 3±0.2 seconds fully in molten solder M705 with			
		a temperature of 245±5℃.			
		More than 90% of the electrode sections shall be couered			
		with new solder smoothly when the sample is taken out of the solder bath.			

MECHANICAL

TEST ITEM	SPECIFICATION			
Resistance to Soldering heat	There shall be no damage or problems.	Temperature profile of reflow soldering 300		

ELECTRICAL

TEST ITEM	SPECIFICATION	TEST DETAILS
Insulation	There shall be	DC 100V voltage shall be applied across this sample of top
resistance	no other	surface and the terminal.
	damage or	The insulation resistance shall be more than $1 \times 10^8 \Omega$.
	problems.	
Dielectric	There shall be	AC 100V voltage shall be applied for 1 minute acrosset the top
withstand	no other	surface and the terminal of this sample
voltage	damage or	
	problems.	
Temperature	∆L/L20°C ≦±10%	The test shall be performed after the sample has stabilized in
characteristics	0~2000 ppm/℃	an ambient temperature of -20 to +85 $^{\circ}\mathrm{C}$,and the value
		calculated based on the value applicable in a normal
		temperature and narmal humidity shall be △L/L20℃ ≦±10%.



ENVIROMENT CHARACTERISTICS

TEST ITEM				SPECIFICATION		
High temperature	∆L/Lo≦±5%	The sam	The sample shall be left for 96±4 hours in an atmospere with			
storage		a temperature of 85±2 $^{\circ}$ C and a normal humidity.				
	There shall be	Upon completion of the measurement shall be made after the				
	no mechanical	echanical sample has been left in a normal temperature and normal				
	damage.	humidity	humidity for 1 hour.			
Low temperature	∆L/Lo≦±5%	The sam	The sample shall be left for 96±4 hours in an atmosphere with			
storage		a temper	a temperature of -25±3℃.			
	There shall be	Upon co	Upon completion of the test, the measurement shall be made			
	no mechanical	after the	after the sample has been left in a normal temperature and			
	damage.	lamage. normal humidity for 1 hour.				
Change of	∆L/Lo≦±5%	The sam	The sample shall be subject to 5 continuos cycles, such as shown			
temperature		in the table 2 below and then it shall be subjected to standard				
	There shall be	-	atmospheric conditions for 1 hour, after which measurement			
	no other dama-	shall be	shall be made.			
	ge of problems					
			table 2			
				Temperature	Duration	
			1	−25±3 °C	30 min.	
		-		(Themostat No.1)		
			2	Standard	No.1→No.2	
				atmospheric		
			3	85±2℃	30 min.	
				(Themostat No.2)		
			4	Standard	No.2→No.1	
				atmospheric		
Moisture storage	∆L/Lo≦±5%	The sam	The sample shall be left for 96±4 hours in a temperature of			
		40±2℃ and a humidity(RH) of 90~95%.				
	There shall be	Upon completion of the test, the measurement shall be made				
	no mechanical	after the	after the sample has been left in a normal temperature and			
	damage.	normal h	normal humidity more than 1 hour.			
Test conditions :						
The	sample shall be reflov	w soldered	onto	the printed circuit board	in every test.	

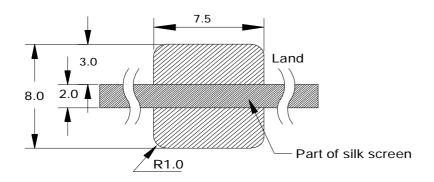


(5) LAND DIMENSION (Ref.)

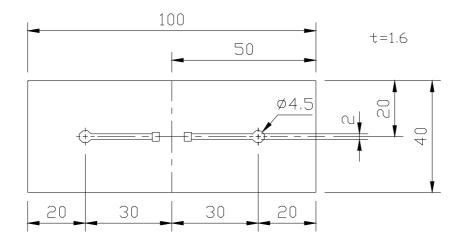
PCB: GLASS EPOXY t=1.6mm

(5)-1 LAND PATTERN DIMENSIONS

(STANDARD PATTERN) Unit:mm



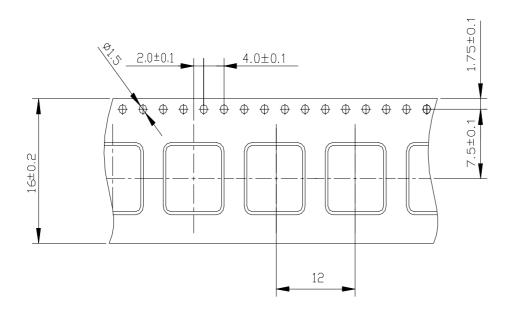
(5)-2 SUBSTRATE BENDING TEST BENDING TEST BOARD





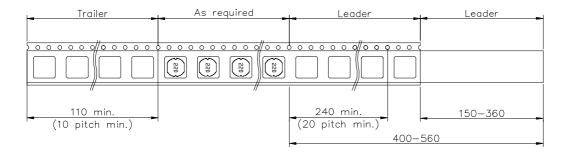
(6) PACKAGING

(6)-1 CARRIER TAPE DIMENSIONS (mm)

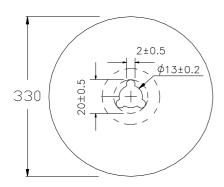


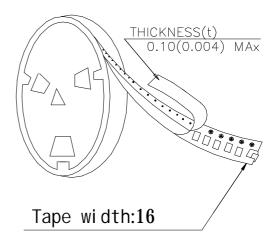
(6)-2 TAPING DIMENSIONS (mm)





(6)-3 REEL DIMENSIONS (mm)





(6)-4 QUANTITY

1000 pcs/Reel

The products are packaged so that no damage will be sustained.